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FAIRCHILD SEMICONDUCTOR

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October 2001

Si6426DQ

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20V N-Channel PowerTrench[®] MOSFET

NW.OZSC

General Description

This N-Channel MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gate drive voltage ratings (2.5V to 8V).

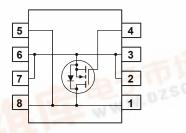
Applications

- Battery protection
- DC/DC conversion
- · Power management
- Load switch

Features

- 5.4 A, 20 V $R_{DS(ON)}$ = 35 m Ω @ V_{GS} = 4.5 V $R_{DS(ON)}$ = 40 m Ω @ V_{GS} = 2.5 V
- Extended V_{GSS} range (±8V) for battery applications
- High performance trench technology for extremely W.DZSC.C low R_{DS(ON)}
- Low profile TSSOP-8 package





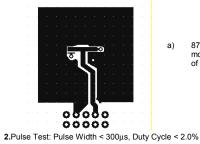
Absolute Maximum Ratings TA=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		20	V
V _{GSS}	Gate-Source Voltage		± 8	V
I _D	Drain Current – Continuous	(Note 1)	5.4	A
	– Pulsed		30	2 ()
PD	Power Dissipation	(Note 1a)	1.4	W
		(Note 1b)	1.1	L D V
T _J , T _{STG}	Operating and Storage Junction Temperatu	ire Range	-55 to +150	°C
Therma	al Characteristics			
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1a)	87	°C/W
$R_{\theta JA}$			114	1

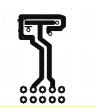
Device Marking	Device	Reel Size	Tape width	Quantity
6426	Si6426DQ	13"	16mm	3000 units

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Symbol	Falameter	Test conditions		тур	Wax	Units
Off Char	racteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 μ A	20			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, Referenced to 25°C		14		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 20 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
		V_{DS} = 20 V, V_{GS} = 0 V, T_J =55°C			5	
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
I _{GSSR}	Gate–Body Leakage, Reverse	$V_{GS} = -8 V$, $V_{DS} = 0 V$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, \qquad I_D = 250 \ \mu A$	0.6	0.9	1.5	V
<u>ΔV_{GS(th)}</u> ΔT _J	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-3		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance	$V_{GS} = 4.5 V, I_D = 5.4 A$ $V_{GS} = 2.5 V, I_D = 4.9 A$		23 33	35 40	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5 V$, $V_{DS} = 5 V$	20			Α
		V _{GS} = 2.5 V, V _{DS} = 5 V	8			
g _{FS}	Forward Transconductance	$V_{DS} = 10 V$, $I_D = 5.4 A$		11		S
- Dvnamio	c Characteristics			1	1	
C _{iss}	Input Capacitance	$V_{DS} = 10 V$, $V_{GS} = 0 V$,		710		pF
Coss	Output Capacitance	f = 1.0 MHz	-	173		pF
C _{rss}	Reverse Transfer Capacitance	1		84		pF
	ng Characteristics (Note 2)			1	1	
t _{d(on)}	Turn–On Delay Time	$V_{DD} = 6 V$, $I_D = 1 A$,		7	14	ns
tr	Turn–On Rise Time	$V_{GS} = 4.5 V$, $R_{GEN} = 6 \Omega$		17	31	ns
t _{d(off)}	Turn–Off Delay Time	-		16	29	ns
t _f	Turn–Off Fall Time	1		3	6	ns
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V$, $I_F = 1.5 A$, $dI_F/dt = 100A/\mu s$		14	100	ns
Qg	Total Gate Charge	$V_{DS} = 6 V$, $I_D = 5.4 A$,		7	10	nC
Q _{gs}	Gate–Source Charge	V _{GS} = 4.5 V		1.5		nC
Q _{gd}	Gate–Drain Charge	1		1.2		nC
Drain-S	ource Diode Characteristics	and Maximum Ratings				
l _s	Maximum Continuous Drain–Source				1.25	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 1.25 A$ (Note 2)		0.7	1.2	V

1. $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 87°C/W when mounted on a 1in² pad of 2 oz copper.

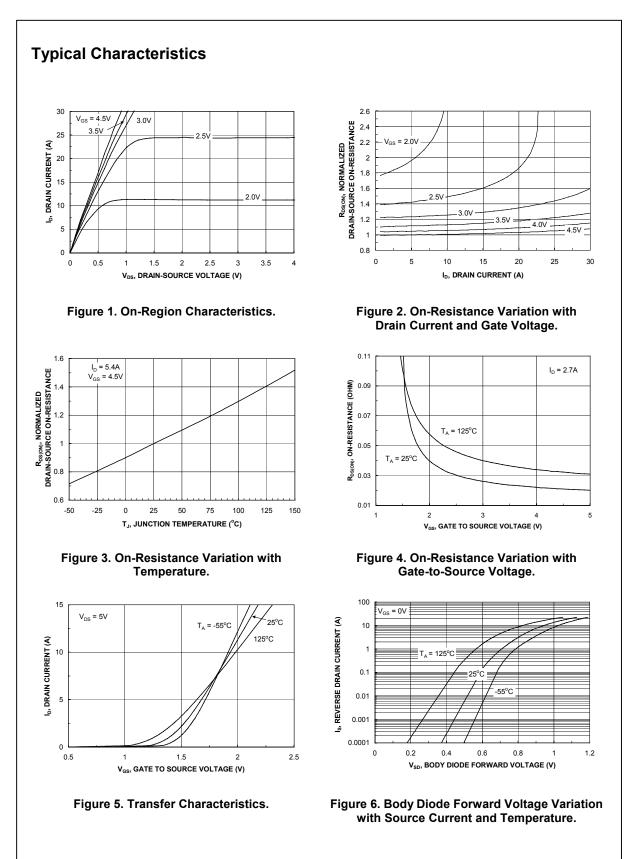


b) 114°C/W when mounted on a minimum pad of 2 oz copper.

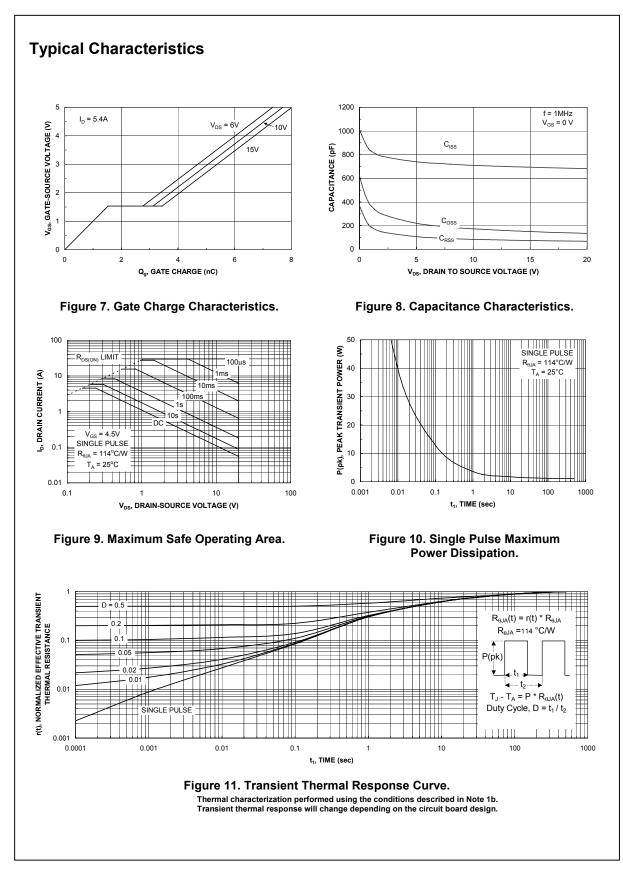
Scale 1 : 1 on letter size paper

c)

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